

<b>INFORMATION DISCLOSURE STATEMENT TRANSMITTAL</b>  To Commissioner For Patents Enclosed herewith is a Form PTO-1449, any required copies of documents listed thereon, and any concise explanation of their relevance is indicated below per 37 CFR 1.97.		<b>Application Number</b>	
		<b>Filing Date</b>	
		<b>First Named Inventor</b>	JACQUEMIN, JEAN-PHILIPPE
		<b>Group Art Unit</b>	
		<b>Examiner Name</b>	
		<b>Atty. Docket Number</b>	FR02 0118 US

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. <sup>1</sup>	Document Number No.-Kind Code <sup>2</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns Lines, Where Relevant Passages or Relevant Figures Appear
	1	US- 3 605 486	09/20/1971	N. C. ADERHOLM ET AL	
	2	US- 5 438 402	08/01/1995	GUPTA VIJAY	
	3	US- 4 972 720	11/27/1990	WU WEN-LI	
	4	US- 5 838 446	11/17/1998	METH JEFFREY S. ET AL.	
		US-			
		US-			

FOREIGN PATENT DOCUMENTS					
Examiner Initials*	Cite No. <sup>1</sup>	Document Number (ctry.-no.-kind <sup>2</sup> , if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of cited document	Pages, Columns Lines, Where Relevant Passages or Relevant Figures Appear
	1	FR 2 681 427	03/19/1993	BAUDINAUD VINCENT	

NON-PATENT LITERATURE DOCUMENTS					
Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in capital letters), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.			
	1	A. W. STEPHENS AND J. L. VOSSEN: "ABSTRACT: MEASUREMENT OF INTERFACIAL BOND STRENGTH BY LASER SPALLATION"; JOURNAL OF VACUUM SCIENCE AND TECHNOLOGY; Vol. 13, no. 1; February 1976; pages 38-29			
	2	J. H. JEONG ET AL: "INTRINSIC STRESS IN CHEMICAL VAPOUR DEPOSITED DIAMOND FILMS: AN ANALYTICAL ..."; JOURNAL OF APPLIED PHYSICS 90(3); Pages 1227-1236; Aug. 1, 2001.			
	3	MICHEL GODIN ET AL. "QUANTITATIVE SURFACE STRESS MANagements USING A MICROCANTILEVER"; APPLIED PHYSICS LETTERS 79(4); Pages 551-553; July 23 <sup>rd</sup> , 2001			
	4	R.H. DAUSKARDT ET AL: "ADHESION AND DEBONDING OF MULTI-LAYER THIN FILM STRUCTURES"; ENGINEERING FRACTURE MECHANICS 61(1998); Pages 141-162.			
	5	GURAY TAS ET AL: "ELECTRON DIFFUSION IN METALS STUDIED BY PICOSECOND ULTRASONICS "; PHYSICAL REVIEW; Pages 15 046 - 15 054; Vol. 49 (21); June 1 <sup>st</sup> , 1994.			

<b>Examiner Signature</b>	/David Rogers/	<b>Date Considered</b>	03/16/2010
---------------------------	----------------	------------------------	------------

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. <sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. //DaR//